

Technical Data Sheet

0402 Package Chip LED (0.45 mm Height)

16-213SURC/S530-XX/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 16-213 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

	D . G.I	
Material	Emitted Color	Resin Color
AlGaInP	Brilliant Red	Water Clear



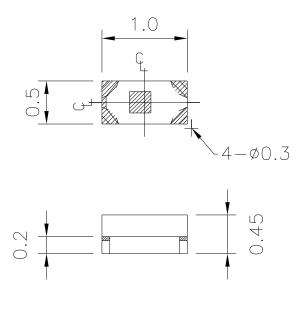
Everlight Electronics Co., Ltd. http://www.everlight.com Rev 3 Page: 1 of 10

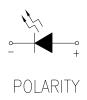
Device No: DSE-0007677 Prepared date: 14-Sep-2012 Prepared by: Jack Chiu Release Date: 2012-09-20 10:03:44.0

LifecyclePhase: Approved Expired Period: Forever

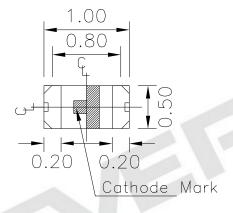


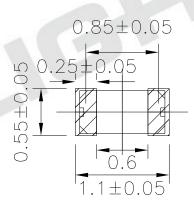
Package Outline Dimensions





Recommend solder pad





Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd.

Device No: DSE-0007677

Revision: 3

LifecyclePhase: Approve

http://www.everlight.com

Prepared date: 14-Sep-2012

Rev 3

Page: 2 of 10

Prepared by: Jack Chiu

Release Date:2012-09-20 10:03:44.0



Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit			
Reverse Voltage	V_R	5	V			
Forward Current	I F	25	mA			
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA			
Power Dissipation	Pd	60	mW			
Electrostatic Discharge(HBM)	ESD	2000	V			
Operating Temperature	Topr	-40 ~ +85				
Storage Temperature	Tstg	-40 ~ +90				
Soldering Temperature	Tsol	Reflow Soldering: 260 Hand Soldering: 350	for 10 sec. for 3 sec.			

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 3 Page: 3 of 10

Device No: DSE-0007677 Prepared date: 14-Sep-2012 Prepared by: Jack Chiu Release Date: 2012-09-20 10:03:44.0

LifecyclePhase: Expired Period: Forever Expired Period: Forever



Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
		A2	15	36			
		A3	25	40			
Luminous Intensity	Iv	A4	36	50		mcd	
		A5	48	70			
		A6	58	89			
Viewing Angle	2 1/2			120		deg	I _F =20mA
Peak Wavelength	p			632		nm	
Dominant Wavelength	d			624		nm	
Spectrum Radiation Bandwidth				20		nm	
Forward Voltage	VF		1.7	2.0	2.4	V	
Reverse Current	IR			4-6	10	μA	V _R =5V

*16-213SURC/S530-<u>XX/</u>TR8



Everlight Electronics Co., Ltd. http://www.everlight.com Rev 3 Page: 4 of 10

Device No: DSE-0007677 Prepared date: 14-Sep-2012 Prepared by: Jack Chiu Revision : 3 Release Date: 2012-09-20 10

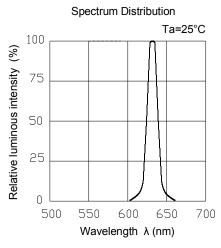
Revision : 3

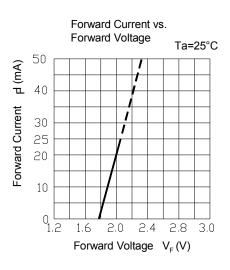
LifecyclePhase: Approved

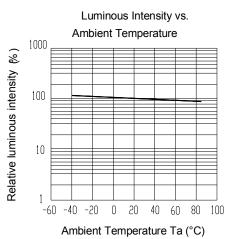
Expired Period: Forever

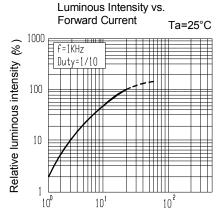


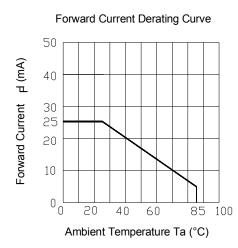
Typical Electro-Optical Characteristics Curves

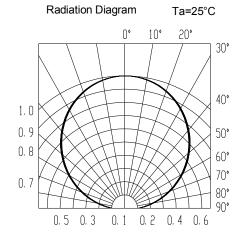












Everlight Electronics Co., Ltd. http://www.everlight.com Rev 3 Page: 5 of 10

Device No: DSE-0007677 Prepared date: 14-Sep-2012 Prepared by: Jack Chiu **Revision**

Release Date:2012-09-20 10:03:44.0 : 3

LifecyclePhase: **Expired Period: Forever** Approved

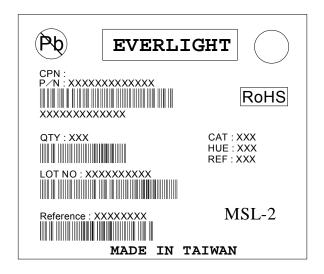


Label Explanation

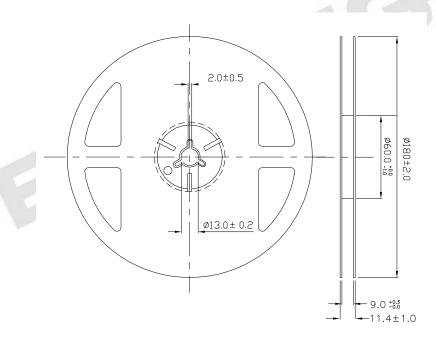
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd.

Device No: DSE-0007677

Revision : 3

LifecyclePhase: 正式發行 Approved

http://www.everlight.com

Prepared date: 14-Sep-2012

Rev 3

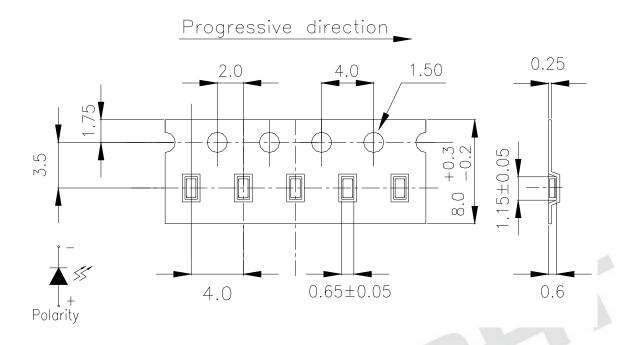
Page: 6 of 10

Prepared by: Jack Chiu

Release Date:2012-09-20 10:03:44.0

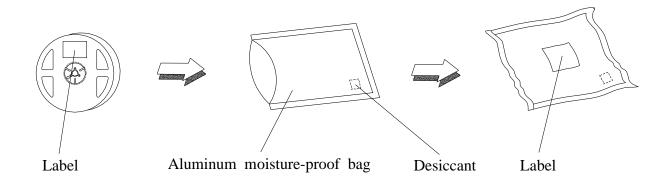


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd.

Device No: DSE-0007677

: 3 LifecyclePhase:

Revision

http://www.everlight.com

Prepared date: 14-Sep-2012

Rev 3

Page: 7 of 10

Prepared by: Jack Chiu

Release Date:2012-09-20 10:03:44.0



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 ±5 Max. 10sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100 15min 5 min L: -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100 5min 10 sec L:-10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 3 Page: 8 of 10

Device No: DSE-0007677 Prepared date: 14-Sep-2012 Prepared by: Jack Chiu Release Date: 2012-09-20 10:03:44.0

LifecyclePhase: 正式發行 Approved Expired Period: Forever



Precautions For Use

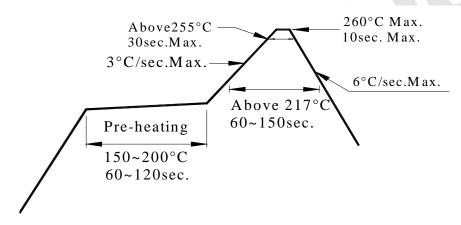
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less.

 If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5 for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd.

Approved

_

Rev 3 Page: 9 of 10

Device No: DSE-0007677 **Revision** : 3

LifecyclePhase:

Prepared date: 14-Sep-2012

http://www.everlight.com

Prepared by: Jack Chiu Release Date:2012-09-20 10:03:44.0

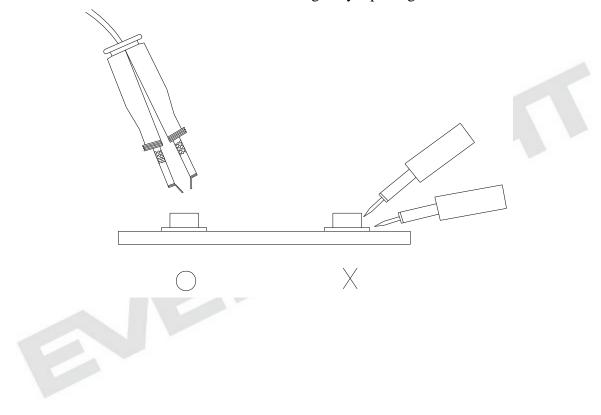


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 3 Page: 10 of 10

Device No: DSE-0007677 Prepared date: 14-Sep-2012 Prepared by: Jack Chiu

Revision : 3 Release Date:2012-09-20 10:03:44.0

LifecyclePhase: Approved Expired Period: Forever